Silicon NPN Epitaxial

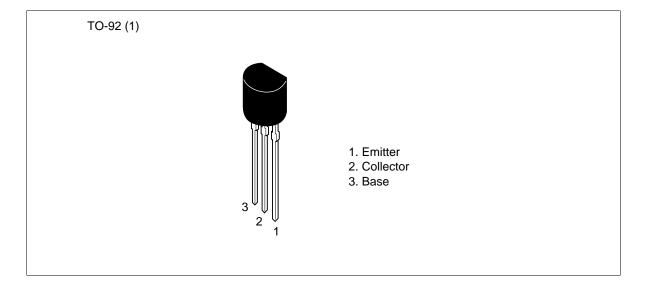
HITACHI

ADE-208-1049 (Z) 1st. Edition Mar. 2001

Application

- Low frequency amplifier
- Medium speed switching

Outline





Absolute Maximum Ratings (Ta = 25°C)

Item	Symbol	Ratings	Unit
Collector to base voltage	V_{CBO}	50	V
Collector to emitter voltage	V _{CEO}	50	V
Emitter to base voltage	V_{EBO}	4	V
Collector current	I _c	500	mA
Collector power dissipation	P _c	400	mW
Junction temperature	Tj	150	°C
Storage temperature	Tstg	-55 to +150	°C

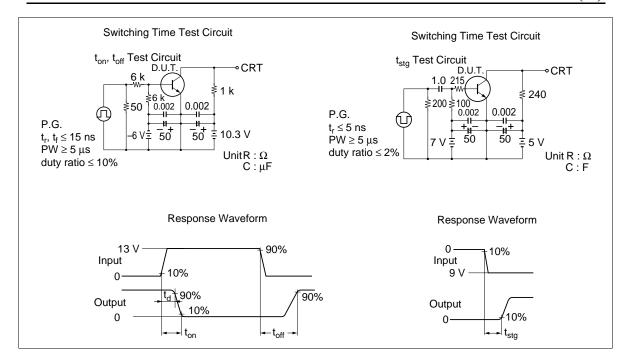
Electrical Characteristics ($Ta = 25^{\circ}C$)

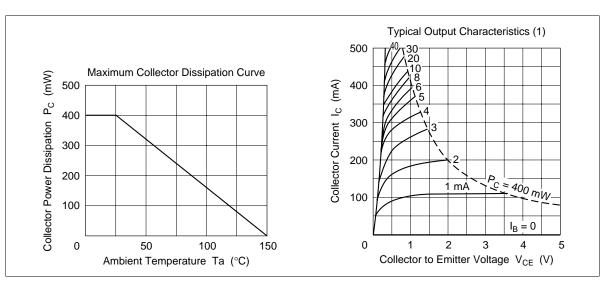
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Collector to base breakdown voltage	$V_{(BR)CBO}$	50	_	_	V	$I_{c} = 10 \ \mu A, \ I_{E} = 0$
Collector to emitter breakdown voltage	$V_{(BR)CEO}$	50	_	_	V	$I_C = 1.0 \text{ mA}, R_{BE} = \infty$
Emitter to base breakdown voltage	$V_{(BR)EBO}$	4	_	_	V	$I_{E} = 10 \mu A, I_{C} = 0$
Collector cutoff current	I _{CBO}	_	_	0.5	μΑ	$V_{CB} = 20 \text{ V}, I_{E} = 0$
DC current transfer ratio	h _{FE} *1	60	_	320		$V_{CE} = 3 \text{ V}, I_{C} = 10 \text{ mA}$
	h _{FE}	10	_	_		$V_{CE} = 3 \text{ V}, I_{C} = 500 \text{ mA}^{*2}$
Base to emitter voltage	V_{BE}		0.64	_	V	$V_{CE} = 3 \text{ V}, I_{C} = 10 \text{ mA}$
Collector to emitter saturation voltage	$V_{\text{CE(sat)}}$	_	0.12	0.6	V	$I_{\rm C}$ = 150 mA, $I_{\rm B}$ = 15 mA* ²
Base to emitter satruation voltage	$V_{BE(sat)}$	_	0.83	1.2	V	$I_{\rm C}$ = 150 mA, $I_{\rm B}$ = 15 mA* ²
Collector output capacitance	Cob	_	7.0	_	pF	$V_{CB} = 10 \text{ V}, I_{E} = 0, f = 1 \text{ MHz}$
Gain bandwidth product	f _T	_	120	_	MHz	$V_{CE} = 3 \text{ V}, I_{C} = 10 \text{ mA}$
Turn on time	t _{on}	_	0.25	_	μS	$V_{CC} = 10.3 \text{ V}$ $I_C = 10 I_{B1} = -10 I_{B2} = 10 \text{ mA}$
Turn off time	t _{off}	_	0.85	_	μS	
Storage time	t _{stg}	_	0.4	_	μS	$V_{CC} = 5 \text{ V}$ $I_{C} = I_{B1} = -I_{B2} = 20 \text{ mA}$

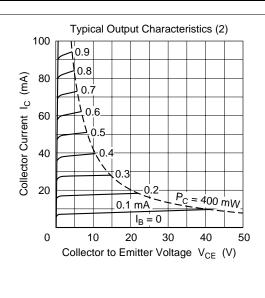
Notes: 1. The 2SC1213A(K) is grouped by h_{FE} as follows.

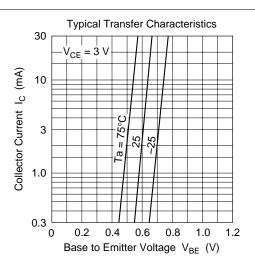
2. Pulse test

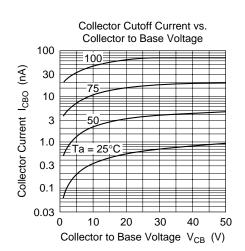
В	С	D
60 to 120	100 to 200	160 to 320

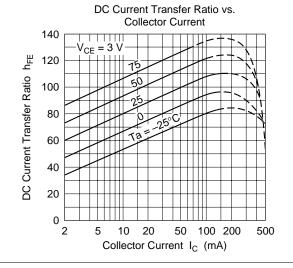


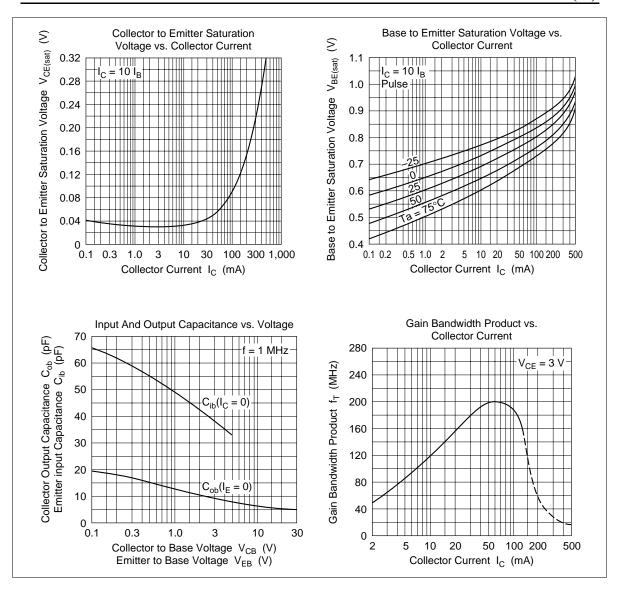


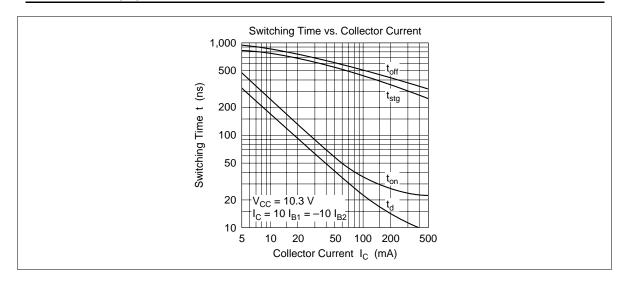




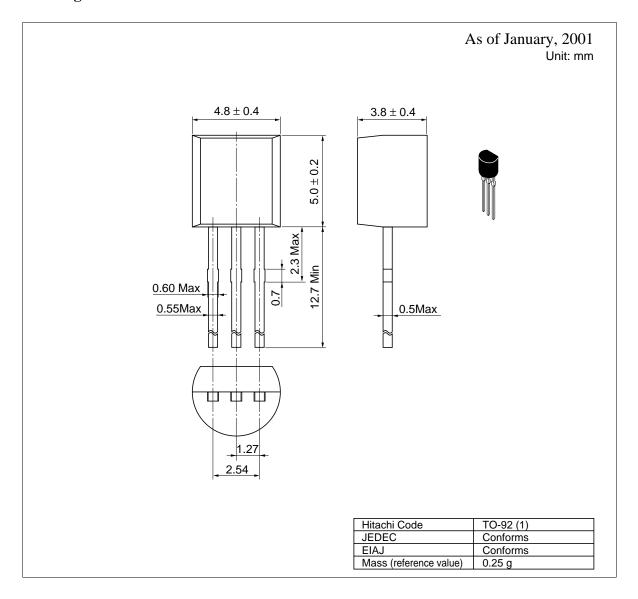








Package Dimensions



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